## Specifications

| Drawing No. | UKY1C-H1-14571-00[43] |
| :---: | :---: |
| I/11 |  |
| Issued Date. | May,16,2014 |

## TO: Digi-Key

Note: In case of specification change, KYOCERA Part Number also will be changed.

| Product Name | Quartz Crystal |
| :---: | :---: |
| Product Model | CX3225SB |
| Frequency | Refer to UKY1C-H1-14571-00[43] 3/11 Nominal Frequency |
| Customer Part Number | - |
| Customer Specification Number | - |
| KYOCERA Part Number | Refer to UKY1C-H1-14571-00[43] 3/11 Nominal Frequency |
| Remarks Pb-Free, RoHS Compliant, MSL 1 |  |

Customer Acceptance

| Accept Signature | Approved Date |  |
| :--- | :---: | :--- |
|  | Department |  |
|  |  |  |
|  | Person in charge |  |

## Seller

KYOCERA Crystal Device Corporation
(Crystal products Sales Division)
6 Takeda Tobadono-cho, Fushimi-ku, Kyoto
612-8501 Japan
TEL. No. 075-604-3500
FAX. No. 075-604-3501

## Manufacturer

Crystal Units Division
5850, Higashine-Koh, Higashine-Shi, Yamagata 999-3701 Japan
TEL. No. 0237-43-5611
FAX. No. 0237-43-5615

| Design Deparment | Quality Assurance | Approved by | Checked by | Issued by |
| :--- | :---: | :--- | :--- | :--- |
| KYOCERACystal Device Corporation <br> Crystal Units Engineering Section <br> Crystal Units Division | A. Kikuchi | Y.Takahashi | T. Nitoube | Y. Kikuchi |

## Revision History

| Rev.No. | Description of revise | Date | Approved by | Checked by | Issued by |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | First Edition | May,16,2014 | Y.Takahashi | T. Nitoube | Y. Kikuchi |
|  |  |  |  |  |  |

[PART NUMBER LIST]

| Nominal Frequency <br> $(\mathrm{MHz})$ | KYOCERA Part Number | ESR <br> $(\Omega)$ | Nominal <br> Frequency <br> Code |
| :---: | :---: | :---: | :---: |
| 12.000 | CX3225SB12000D0FPNCC | 150 | 12000 |

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## 1. APPLICATION

This specification sheet is applied to quartz crystal "CX3225SB"

## 2. KYOCERA PART NUMBER

Refer to UKY1C-H1-14571-00[43] 3/11 Nominal Frequency

## 3. RATINGS

| Items | SYMB. | Rating | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: |
| Operating Temperature | Topr | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature range | Tstg | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |  |

## 4. CHARACTERISTICS

ELECTRICAL CHARACTERISTICS

| Items | Electrical Specification |  |  |  |  | Test Condition | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SYMB. | Min | Typ. | Max | Unit |  |  |
| Mode of Vibration |  | Fundamental |  |  |  |  |  |
| Nominal Frequency | F0 |  | ※1 |  | MHz |  |  |
| Nominal Temperature | $\mathrm{T}_{\text {NOM }}$ |  | +25 |  | ${ }^{\circ} \mathrm{C}$ |  |  |
| Load Capacitance | CL |  | 8.0 |  | pF |  |  |
| Frequency <br> Tolerance | df/F | -10.0 |  | +10.0 |  | $+25 \pm 3^{\circ} \mathrm{C}$ |  |
| Frequency Temperature characteristics | df/F | -25.0 |  | +25.0 | PPM | -40 to $+85^{\circ} \mathrm{C}$ |  |
| Frequency Aging Rate |  | -1.0 |  | +1.0 |  | 1 year | $+25 \pm 3^{\circ} \mathrm{C}$ |
| Equivalent Series Resistance | ESR |  |  | ※2 | $\Omega$ |  |  |
| Drive Level | Pd | 0.01 |  | 100 | $\mu \mathrm{W}$ |  |  |
| Insulation Resistance | IR | 500 |  |  | $\mathrm{M} \Omega$ | 100V(DC) |  |

※1 Refer to UKY1C-H1-14571-00[43] 3/11 Nominal Frequency
※2 Refer to UKY1C-H1-14571-00[43] 3/11 ESR

## 5. APPEARANCES, PHYSICAL DIMENSION

OUTLINE DIMENSION (not to scale)


1 Nominal Frequency Move the number of maximum indication beams of the frequency to five digits, and omit less than kHz .
2 Identification
$[\mathrm{K}]$ mark is surely 1 Pin direction.
3 Date Code Year. - LAST 1 DIGIT of YEARAND WEEK
(Ex)Jan, 01, $2014 \rightarrow 401$
4 Manufacturing Location
Y $\cdots$ Yamagata
Z $\cdots$ Shiga Yohkaichi
$\mathrm{T} \cdots$ Thailand
F‥Philippines

## 6. RECOMMENDED LAND PATTERN (not to scale)



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## 7.TAPING \& REEL

7-1.Dimensions


7-2.Leader and trailer tape


7-3.Direction (The direction shall be seen from the top cover tape side)


## 7-4.Specification

1.Material of the carrier tape shall be polystyrene orA-PET (ESD).
2.Material of the seal tape shall be polyester(ESD).
3.The seal tape shall not cover the sprocket holes. And not protrude from the carrier tape.
4.Tensile strength of the tape : 10N or more.
5. The R of the corner without designation is 0.2RMAX.
6. Disalignment between centers of the cavity and sprocket hole shall be 0.05 mm or less.
7. Cumulative pitch tolerance of " $\mathrm{P}_{0}$ " shall be $\pm 0.2 \mathrm{~mm}$ at 10 pitches.
8. Suppose that it unifies as shown in the above-mentioned figure to the directivity of printing in an embossing tape.
9. Peeling force of the seal tape: 0.1 to 1.0 N .
10.The component can fall headlong naturally from taping in the environment, such dry conditions, when this components were transferred to, cover was removed and the component was moved upside down.


7-5.Reel Specification


In the case of $\Phi 180$ Reel (3,000 pcs max, every 1,000 pcs)

| Symbol | A | B | C | D |
| :--- | :---: | :---: | :---: | :---: |
| Dimension | $\phi 180+0 /-3$ | $\phi 60+1 /-0$ | $\phi 13 \pm 0.2$ | $\phi 21 \pm 0.8$ |
| Symbol | E | W | t |  |
| Dimension | $2.0 \pm 0.5$ | $9 \pm 1$ | $2.0 \pm 0.5$ |  |

(Unit : mm)
In the case of $\Phi 330$ Reel (10,000 pcs max, every 1,000 pcs)

| Symbol | A | B | C | D |
| :--- | :---: | :---: | :---: | :---: |
| Dimension | $\phi 330 \pm 2.0$ | $\phi 100 \pm 1.0$ | $\phi 13 \pm 0.2$ | $\phi 21 \pm 0.8$ |
| Symbol | E | W | t |  |
| Dimension | $2.0 \pm 0.5$ | $9.5 \pm 0.5$ | $2.2 \pm 0.1$ |  |

## 8. Environmental requirements

After following test, frequency shall not change more than $\pm 10 \times 10^{-6}$
And $\mathrm{Cl}, \pm 20 \%$ or $5 \Omega$ of large value.
8.1 Resistance to Shock

Test condition
Natural dropped from height 100 cm onto hard wood
board in 3 times
8.2 Resistance to Vibration Test condition

| frequency | $: 10-55-10 \mathrm{~Hz}$ |
| :--- | :--- |
| Amplitude | $: 1.5 \mathrm{~mm}$ |
| Cycle time | $: 15$ minutes |
| Direction | $: X, Y, Z$ (3direction),2 h each. |

8.3 Resistance to Heat

Test condition
The quartz crystal unit shall be stored at a temperature of $+85 \pm 2^{\circ} \mathrm{C}$ for 500 h .
Then it shal be subjected to standard atmospheric conditions for 1 h ,after whichi measurement shall be made.
8.4 Resistance to Cold Test condition

The quart crystal unit shall be stored at a temperature of $-40 \pm 2^{\circ} \mathrm{C}$ for 500 h .

Then it shal be subjected to standard atmospheric conditions for 1 h ,after whichi measurement shall be made.
8.5 Thermal Shock

Test condition
The quartz crystal unit shall be subjected to 500 succesive change of temperature cycles, each as shown in table below, Then it shall be subjected to standard atmospheric conditions for 1 h , after which measurements shall be made.

$$
\begin{gathered}
\text { Cycle } \quad:-40 \pm 2^{\circ} \mathrm{C}(30 \mathrm{~min} .) \text { to }+25 \pm 2^{\circ} \mathrm{C} \text { (5min.) } \\
\\
\text { to } \left.+85 \pm 2^{\circ} \mathrm{C} \text { (30min.) to }+25 \pm 2^{\circ} \mathrm{C} \text { (5min. }\right)
\end{gathered}
$$

## Test condition

The quartz crystal unit shall be stored at a temperature of $+60 \pm 2^{\circ} \mathrm{C}$ wich relative humidity of $90 \%$ to $95 \%$ for 240 h . Then it shall be subjected to standard atmospheric conditions for 1 h , after which measurements shall be made

### 8.7 Soldering condition

1.) Material of solder

Kind $\cdots$ lead free solder paste
Melting point $\cdots+220 \pm 5^{\circ} \mathrm{C}$
2.) Reflow temp.profile

|  | Temp [ $\left.{ }^{\circ} \mathrm{C}\right]$ | Time[sec] |
| :---: | :---: | :---: |
| Preheating | +150 to +180 | 150 (typ.) |
| Peak | $+260 \pm 5$ | 10 (max.) |
| Total | - | 300 (max.) |

Frequency shift : $\pm 2 \mathrm{ppm}$
3.) Hand Soldering $\quad+350^{\circ} \mathrm{C} 3 \mathrm{sec}$ MAX
4.) Reflow Times 2 times

Reflow temp.profile

8.8 Intensity for bending in circuit board

Solder this product in center of the circuit board of $40 \mathrm{~mm} \times 100 \mathrm{~mm}$, and add the deflection of 3 mm as the bottom figure.

Test board : $\mathrm{t}=1.6 \mathrm{~mm}$


UNIT : mm

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Drawing No. 
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## 9. Cautions for use

(1) Soldering in mounting In case of Solder paste and conductive glue contact product lid or product side face exception for product terminal it's possible to influence product characteristics. Please be careful above contents.
(2) Automatic mounting machine use

Please use after affirmation that select the mounting machine model with a shock small if possible in the case of use of an automatic mounting machine, and it does not have breakage. There is a risk of a quartz crystal unit breakage occurring and not functioning normally by too much shock etc.
(3) Conformity of a circuit

In case of use of an oscillation circuit, please insert in a crystal oscillating child in series resistance 5 times as many as the standard value of equivalent in-series resistance, and confirm oscillating. Please remove resistance which inserted after the notes above-mentioned examination in the quartz crystal unit in series, and use it.

## 10. Storage conditions

Storage at prolonged high temperature or low temperature and the storage by high humidity cause degradation of frequency accuracy, and degradation of soldering nature. Storage is performed at the temperature of +18 to $+30^{\circ} \mathrm{C}$, and the humidity of 20 to $70 \%$ in the state of packing, and a term is 6 months.

## 11. Manufacturing location

Kyocera Crystal Device Corporation
Kyocera Crystal Device Corporation Shiga Yohkaichi Plant
Kyocera Crystal Device (Thailand) Co., Ltd
Kyocera Crystal Device Philippines, Inc.

## 12. Quality Assurance

Kyocera Crystal Device Quality Assurance Division

## 13. Quality guarantee

When the failure by the responsibility of our company occurs clearly after delivery within 1 year, a substitute article etc. is appropriated gratuitously and this is guaranteed. However, when passing 1 year after delivery, there is a case where I am allowed to consider as onerous repair after both consultation.

## 14. Others

When any questions and opinions are in the written matter of these delivery specifications, I will ask connection of you from the company issue day within 45 days. In a connection no case, a written matter is consented to it and employed within a term.

